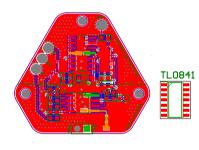
NOTES:

- (1) 2 Layer Board with 0.6mm thickness.
 (2) Minimum clearance = 0.15mm
 (3) Minimum track width = 0.15mm
 (4) Vias drill minimum diameter = 0.25mm and overall minimum diameter = 0.5mm

LAYER STACK UP

LAYERS REPERSENTATION



Layer	Name	Material	Thickness	Constant	Board Layer Stack
	Top Overlay				
	Top Solder	Solder Resist	O. 010mm	3.5	
1	TOP	CF-004	0.035mm		
	Dielectric1	Core-042	0.500mm	4.8	
2	BOTTOM	CF-004	0.035mm		
	Bottom Solder	Solder Resist	O. 010mm	3.5	
	Bottom Overlay				
Total	board thicknoon	*	0.590		·

Total board thickness:

0.590mm

Top Overlay Top Paste Top Solder TOP BOTTOM Bottom Solder Bottom Paste Bottom Overlay BoardOutline ManufacturingNotes Top Assembly Bottom Assembly Keep-Out Layer Top Pad Master Bottom Pad Master Drill Drawing Drill Guide Profile

Board Stack Report